

TACT Switch™ 4.5×4.5mm Compact (Snap-in type)

SKHR Series



Compact snap-in type contribute to improve high density mounting.

Detector

Push

Slide

Rotary

Encoders

Power

Dual-in-line
Package Type

Multi Control
Devices

TACT Switch™

Custom-
Products

Sharp
Feeling

Soft
Feeling

Snap-in
Type

Surface
Mount Type

Radial
Type



Features

- Snap-in type allows the switch to be mounted directly onto the PC board.
- Part of the output terminal can also be applied as jumper leads, making circuit design easier.

Applications

- For various operation in audio equipment, office devices, communication devices, measuring devices, TVs and VCRs

Product Line

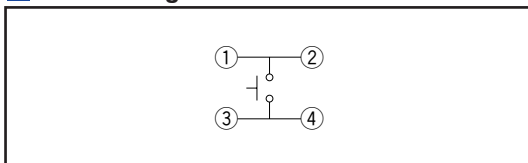
Product No.	Operating force	Operating direction	Travel (mm)	Rating (max.)	Rating (min.)	Operating life (5mA 5V DC)	Initial contact resistance	Stem color	Minimum packing unit (pcs.)
SKHRAAA010	0.98N	Vertical	0.25	50mA 12V DC	10μA 1V DC	50,000cycles	100mΩ max.	Black	1,000
SKHRABA010	1.57N					30,000cycles		Dark gray	
SKHRAHA010	2.55N					50,000cycles		Red	

Dimensions

Unit:mm

Style	PC board mounting hole dimensions (Viewed from switch mounting face)

Circuit Diagram



Note

Please use 1.6mm thick PC boards.

Refer to P.373 for product specifications.
Refer to P.374 for soldering conditions.

Product Specifications

Items		Series	Sharp feeling type	Soft feeling type
		Operating temperature range		
	-30°C to +85°C			-40°C to +90°C
Electrical performance	Insulation resistance	100MΩ min. 100V DC SKEY/PD : 50MΩ min. 100V DC		
	Voltage proof	250V AC for 1minute SKRE/SC/RB/RM/RW/RR/EY/PD : 100V AC for 1minute		
Durability	Vibration	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2hours respectively		
	Lifetime	Shall be in accordance with individual specifications.		
Environmental performance	Cold	-30±2°C for 96h		
	Dry heat	80±2°C for 96h		
	Damp heat	60±2°C, 90 to 95%RH for 96h		

Detector

Push

Slide

Rotary

Encoders

Power

Dual-in-line
Package TypeMulti Control
Devices

TACT Switch™

Custom-
Products

Note

The automotive operating temperature range to be individually discussed upon request.

Specifications of LED (SKHJ)

Color of illumination	Power dissipation P (mW)	Forward pulse peak current IFP (mA)	Forward current IFDC (mA)	Reverse voltage VR (V)	Forward voltage VF (V) IF=10mA	Reverse current IR (μA) VR=4V	Peak emission wave length λ peak (nm) IF=10mA	Spectral line half width Δλ (nm) IF=10mA	Luminous intensity IV (mcd) IF=10mA		
Red	40	80	15	4	2.7 max. 2.05TYP	5 max.	700 TYP	100 TYP	0.4min. 1.0 TYP		
Pure green							555 TYP	20 TYP	0.8min. 2.0 TYP		
Amber							590 TYP	30 TYP	0.4min. 1.0 TYP		
Orange (High brightness)						3	2.7 max. 2.0 TYP	10 max.	630 TYP	40 TYP	1.5min. 4.0 TYP
Green (High brightness)						4	2.7 max. 2.05TYP		565 TYP	30 TYP	2.0min. 5.0 TYP

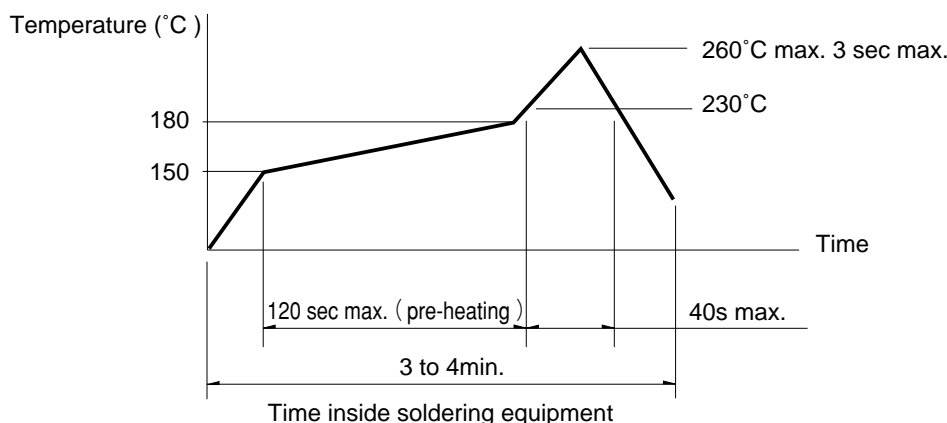
Sharp
FeelingSoft
FeelingSnap-in
TypeSurface
Mount TypeRadial
Type

Soldering Conditions

Condition for Reflow

Available for Surface Mount Type.

1. Heating method: Double heating method with infrared heater.
2. Temperature measurement: Thermocouple 0.1 to 0.2 φ CA (K) or CC (T) at solder joints (copper foil surface). A heat resistive tape should be used to fix thermocouple.
3. Temperature profile



Note

1. The above temperature shall be measured on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.
2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Conditions for Auto-dip

Available for Snap-in Type and Radial Type
(Except SKHJ, SKHL, SKQJ, SKQK, SKEG series)

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

Notes

1. Consult with us for TACT Switch™ washing conditions.
2. Prevent flux penetration from the top side of the TACT Switch™.
3. Switch terminals and a PC board should not be coated with flux prior to soldering.
4. The second soldering should be done after the switch returns to normal temperature.
5. Use the flux with a specific gravity of min 0.81.
(EC-19S-8 by TAMURA Corporation, or equivalents.)

Manual Soldering (Except SKRT series)

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

Detector
Push
Slide
Rotary
Encoders
Power
Dual-in-line Package Type
Multi Control Devices
TACT Switch™
Custom-Products

Sharp Feeling
Soft Feeling
Snap-in Type
Surface Mount Type
Radial Type